

# NC254 Paste Flux

# **Paste Flux**

#### **Features:**

- Excellent Wetting - Wide Process Window - Tin-Lead and Lead-Free Compatible - Used for Ball Attach

# **Description:**

NC254 Paste Flux is a no clean tacky/rework flux designed to wet virtually all solderable electronic surfaces, components, assemblies, and substrates. AIM NC254 Paste Flux may be used for general touch up or rework of printed circuit boards, and for attaching spheres to ball grid array (BGA) packages. The superior wetting ability of NC254 Paste Flux results in bright, smooth and shiny solder joints whether reflowed by hand, hot-air rework station, convection reflow oven, or vapor phase soldering systems. Residues that remain on surfaces after soldering are clear, leaving a cosmetically appealing repair that can be easily pin probed during in-circuit test. NC254 Paste Flux is compatible with all tin-lead and lead-free alloys and is suitable for a wide range of applications. NC254 Paste Flux can be brushed, dispensed, pin transferred, or stencil printed. NC254 Paste Flux is available in 10cc and 30cc syringes.

## **Flux Application:**

- When being used in rework, application should be limited to the area being worked.
- Application via dispense needle, brush or a cotton swab is recommended.
- NC254 Paste Flux needs to see an SMT style reflow profile to render it fully inactive.

#### **Cleaning:**

- NC254 Paste Flux can be cleaned, if necessary, with saponified water or an appropriate solvent cleaner.
- Please refer to the AIM Cleaner Matrix for a list of suitable cleaning materials.

## Handling and Storage:

- NC254 Paste Flux has a refrigerated shelf life of 1 year at 4°C (40°F) to 12°C (55°F), and 6 months at room temperature.
- Allow the paste flux to warm up completely and naturally to ambient temperature (2 hrs.) prior to use.
- Do not store new and used paste flux in the same container.

#### Safety:

- Use with adequate ventilation and proper personal protective equipment.
- Refer to the accompanying Material Safety Data Sheet for any specific emergency information.
- Do not dispose of any hazardous materials in non-approved containers.

## **Physical Properties:**

Parameter	Value
J-STD-004	ROL0
Acid Number	105-120 mg KOH per gram flux

Parameter	Value
Viscosity	Gel-like consistency
Residues	Amber

Canada +1-514-494-2000 · USA +1-401-463-5605 · Mexico +52-656-630-0032 · Europe +44-1737-222-258 Asia-Pacific +86-755-2993-6487 · India +91-80-41554753 · info@aimsolder.com · www.aimsolder.com

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